INFORMATION

MODEL: SG-210SCBA

INFO. No.: A13-1183-1B

DATE: Mar. 6. 2014

SEIKO EPSON CORPORATION

8548 Naka-minowa Minowa-machi Kamiina-gun Nagano-ken 399-4696 Japan

INTRODUCTION

- 1. The contents is subject to change without notice. Please exchange the specification sheets regarding the product's warranty.
- 2. This sheet is not intended to guarantee or provide an approval of implementation of industrial patents.
- 3. We have prepared this sheet as carefully as possible. If you find it incomplete or unsatisfactory in any respect, We would welcome your comments.

This product is compliant with RoHS Directive.

This Product supplied (and any technical information furnished, if any) by Seiko Epson Corporation shall not be used for the development and manufacture of weapon of mass destruction or for other military purposes. Making available such products and technology to any third party who may use such products or technologies for the said purposes are also prohibited.

This product listed here is designed as components or parts for electronics equipment in general consumer use. We do not expect that any of these products would be incorporated or otherwise used as a component or part for the equipment, which requires an extra high reliability, such as satellite, rocket and other space systems, and medical equipment, the functional purpose of which is to keep life.

This SG-210SCBA is authorized for Use of motor monitor for automobile only.

Model

The model is SG-210SCBA.

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[1] Absolute maximum ratings SCB

Parameter	Symbol	Value	Unit	Note
Supply voltage	Vcc-GND	-0.3 to +5.0	V	
Storage temperature *	T_stg	-40 to +125	°C	Stored as bare product after unpacking.
Input voltage	Vin	-0.3 to Vcc+0.3	V	ST Terminal

^{*} Concerning the frequency change, please refer [8] Environmental and mechanical characteristics.

[2] Operating range

			Value			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage	Vcc	2.7	3.3	3.6	V	
Supply voltage	GND	0.0	0.0	0.0	V	
Input voltage	Vin	GND	1	Vcc	V	
Operating temperature	T_use	-40	+25	+125	°C	Z
Output load condition	L_CMOS	-	-	15	pF	

[•] Start up time(0 %Vcc \rightarrow 90 %Vcc) of power source should be more than 150 μ s.

(Refer to [11] Recommendable patterning)

[3] Frequency characteristics

Output frequency (fo)10.000 MHz

Parameter	Symbol	Value[1 × 10 ⁻⁶]	Note
Frequency tolerance *	<u>f</u> tol (OSC)	Z: ±100	T_use=-40 °C to +125°C
Aging	F_aging	± 3	T_use=+25 °C, Vcc=3.3 V First year

^{*} This includes initial frequency tolerance, temperature characteristics, input voltage characteristics, and load characteristics, but excludes aging.

[•] By-pass capacitor (0.01 μF to 0.1 μF) is connected near Vcc between Vcc and GND.

[4] Terminal assignment

Top View #3

#1	#2

Terminal name	Terminal No.	Terminal type.
ST	1	INPUT
GND	2	_
OUT	3	OUTPUT
Vcc	4	_

 \overline{ST} pin: High or open. \rightarrow Specified frequency output = enable.

 \overline{ST} pin: Low. \rightarrow Output is high impedance = disabled.

* When the \overline{ST} terminal is not controlled, it should be connected to the Vcc terminal.

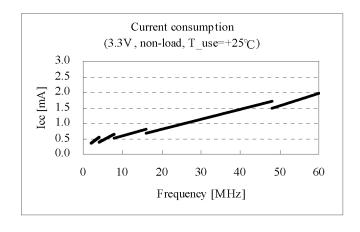
[5] Electrical characteristics

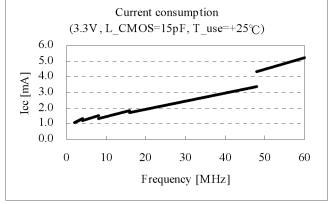
(Please see page 2 [2] Operating range)

		Va	lue		
Parameter	Symbol	Min.	Max.	Unit	Note
Start up time	tosc	-	3	ms	t=0 at 90 %Vcc
Compat consumation	Icc	-	3.0	mA	No load
Current consumption	Icc	-	4.0	IIIA	No load Ta<+125 °C
Standby averant	Latd	-	1.0		ST =GND
Standby current	I_std	-	3.0	μA	\overline{ST} =GND Ta<+125 °C
Output rigo timo	tr	-	3.0	11.0	20 %Vcc → 80 %Vcc
Output rise time	u	-	7.0	ns	$20 \text{ %Vcc} \rightarrow 80 \text{ %Vcc}$ Ta<+125 °C
Output fall time	tf	-	3.0		$80 \text{ %Vcc} \rightarrow 20 \text{ %Vcc}$
Output fall time	ս	-	7.0	ns	$80 \text{ %Vcc} \rightarrow 20 \text{ %Vcc}$ Ta<+125 °C
C	SYM	45	55	%	50 %Vcc Level
Symmetry	311/1	40	60	/0	50 %Vcc Level 50 %Vcc Level
High level output voltage	Vон	0.9 Vcc	-	V	IOH = -1 mA
Low level output voltage	Vol	-	0.1 Vcc	V	IoL = 1 mA
High level input voltage	Vih	0.8 Vcc	-	V	ST terminal
Low level input voltage	VIL	-	0.2 Vcc	V	ST terminal
Input current	Іін	-	10	μΑ	$V_{IN} = V_{CC}$
	IIL	-10	-	μΑ	$V_{IN} = GND$
Output disable time	tstp	-	100	ns	ST terminal High → Low
Output enable time	tsta	Ī	3	ms	ST terminal Low → High
Input pull-up resistance	R_{UP}	1	-	ΜΩ	Vcc=3.3 V, at +25 °C

Refer to [6] Test circuit [7] Timing chart

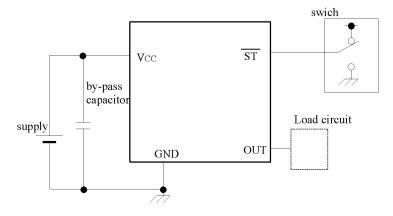
♦ Reference : Current consumption Typ. Value (Vcc = 3.3 V, $T_use = +25 \text{ }^{\circ}\text{C}$)





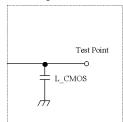
[6] Test circuit

1) Waveform observation

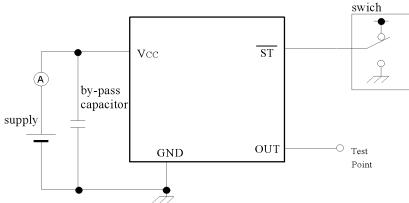


Load circuit

load capacitance



2) Current consumption



*Current consumption under the disable function should be $\overline{ST} = GND$.

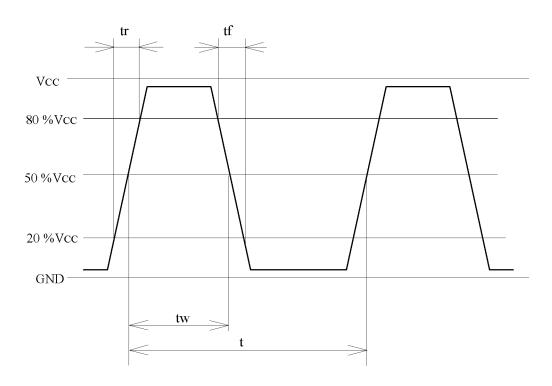
3) Condition

- (1) Oscilloscope
 - Band width should be minimum 5 times higher (wider) than measurement frequency.
 - Probe earth should be placed closely from test point and lead length should be as short as possible.
 - * Recommendable to use miniature socket. (Don't use earth lead.)
- (2) L CMOS also includes probe capacitance.
- (3) By-pass capacitor (0.01 µF to 0.1 µF) is placed closely between Vcc and GND.
- (4) Use the current meter whose internal impedance value is small.
- (5) Power supply
 - Start up time (0 %Vcc \rightarrow 90 %Vcc) of power source should be more than 150 μ s.
 - Impedance of power supply should be as lowest as possible.

[7] Timing chart

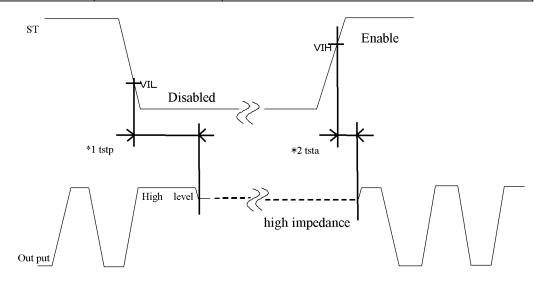
1) C-MOS load

$$SYM = tw/t \times 100 (\%)$$



2) ST function and timing

ST function	Osc. circuit	Output status
High or Open	Oscillation	Specified frequency is output : Enable
Low	Oscillation stop	Output becomes high impedance : Disable



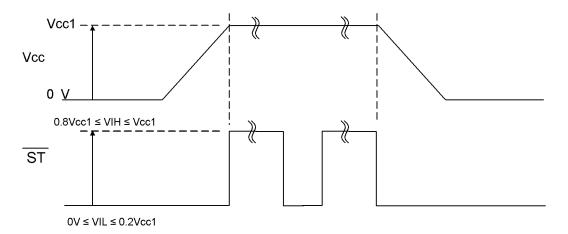
- *1 The time taken from $\overline{ST} = VIL$ to output = Disable (high impedance)
- *2 The time taken from $\overline{ST} = V_{IH}$ to output = Start

Output start : Voh \geq 80 %Vcc, Vol \leq 20 %Vcc, fout = fo \pm 1 000×10⁻⁶

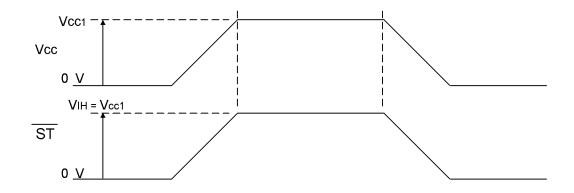
3) ST Control timing

ST function is used on the voltage below supply voltage.

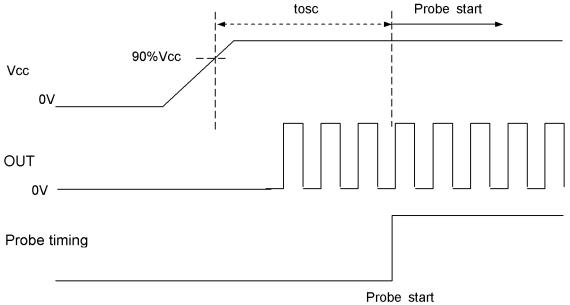
ST control timing differs from Vcc control timing



ST terminal is connected to Vcc terminal



4) Timing of an output frequency signal



[8] Environmental and mechanical characteristics

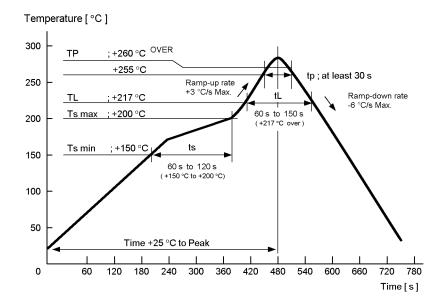
(The company evaluation condition We evaluate it by the following examination item and examination condition.)

		Valu	e *1	Test Conditions
No.	Item	$\Delta f / f *2$ [1 × 10 ⁻⁶]	Electrical characteristics	
1	High temperature storage	*3 ±20		+125 °C × 1 000 h
2	Low temperature storage	*3 ± 10		-40 °C × 1 000 h
3	High temperature bias	*3 ± 20		+125 °C × V _{CC} Max. × 1 000 h
4	Low temperature bias	*3 ± 10		-40 °C × V _{CC} Max. × 1 000 h
5	Temperature humidity bias	*3 ± 10		+85 °C × 85 %RH × V _{CC} Max. × 1 000 h
6	Temperature cycle	*3 ± 10		-40 °C ↔ +125 °C 30 min. at each temperature 1000 cycles
7	Resistance to soldering heat	± 5		Convection reflow soldering furnace (3 time) Ref. IPC/JEDEC J-STD-020D.1
8	Shock	± 3	Satisfy Item [5] after test.	150 g dummy Jig (Epson Toyocom Standard) drop from 1 500 mm height on the Concrete 3 directions 10 times.
9	Vibration	±2		10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s ² 10 Hz \rightarrow 500 Hz \rightarrow 10 Hz 15 min./cycle 6 h (2 hours, 3 directions)
10	Seal	1×10^{-9}	Pa·m³/s	He leakage detector
11	Solderability	Termination movered with f		Dip termination into solder bath at +235 °C ± 5 °C for 5 s. (Using Rosin Flux)
12	Pull - off	No peeling-of		10 N press for 10 s ± 1 s Ref. EIAJ ED-4702

< Notes >

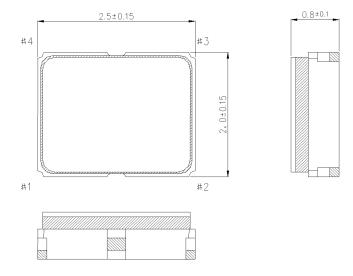
- *1 Each test done independently.
- *2 Measuring 2 h to 24 h later leaving in room temperature after each test.
- *3 Initial value shall be measured after 24 h storage at room temperature after pre-conditioning. Pre-conditioning: Reflow (3 time)

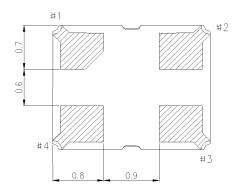
Convection reflow condition (IPC/JEDEC J-STD-020D.1)



[9] Dimensions and marking layout

1) Dimensions

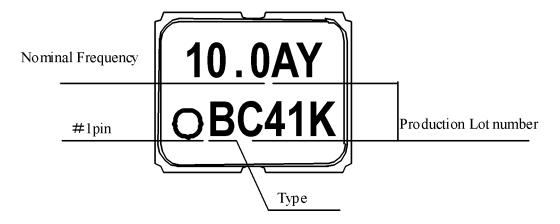




Terminal treatment: Au plating

Unit: mm

2) Marking layout



- ◆ The above marking layout shows only marking contents and their approximate position and it is not for font, size and exact position.
- Output frequency shall indicate 4 digits (include decimal point), if the value of frequency over 4 digits, the least significant digits will be omitted.

[10] Notes

- 1) This device is made with C-MOS IC.

 Please take necessary precautions to prevent damage due to electrical static discharge.
- 2)Seiko Epson recommends a $0.01~\mu F$ to $0.1~\mu F$ capacitor must be connected near Vcc between Vcc and GND to obtain stable operation and protect against power line ripple.
- 3) Vcc and GND pattern shall be as large as possible so that high frequency impedance shall be small.
- 4) Seiko Epson cannot recommend to put filtering element into power line so as to reduce noise. Oscillator might be unstable oscillation because high frequency impedance of power line become higher. When use filtering element, please verify electrical construction and or element's spec.
- 5) Seiko Epson doesn't recommend to power on from intermediate electric voltage or extreme fast power on, Those powering conditions may cause no oscillation or abnormal oscillation.
- 6) Power ripple: 200 mV P-P max. Start up time (0 %Vcc→90 %Vcc) of power source should be more than 150 μs.
- 7) A long output line may cause irregular output, so try to make the output line as short as possible.
- 8) Other high-level signal lines may cause incorrect operation, so please do not place high level signal line close to this device.
- 9) This device contains a crystal resonator, so please don't expose excessive shock or vibration. Seiko Epson recommends store device under normal temperature and humidity to keep the specification.
- 10) An automatic insertion is available, however, the internal crystal resonator might be damaged in case that too much shock or vibration is applied by machine condition.
 Be sure to check your machine condition in advance.
- 11) Ultrasonic cleaning can be used on the SG-210SCBA, however, since the oscillator might be damaged under some conditions, please exercise in advance.
- 12) Seiko Epson recommends to use and store under room temperature and normal humidity to secure frequency accuracy and prevent moisture.
- 13) ST -pin has pull-up resistor internally. The resistor value is switched depending on input voltage. Please refer to electrical characteristics.
- 14) Lid is electrically connected to GND. Please don't apply electrical voltage.

[11] Recommendable patterning

The soldering pad sample indicated as like following:

Soldering position (Unit: mm)

C 0.01 uF~0.1 uF

Resist

#4

#1

1.1

1.7

TAPING SPECIFICATION

I. Application

This standard will apply to 2.5×2.0 Ceramic package.

Spec: CG package

II. Contents

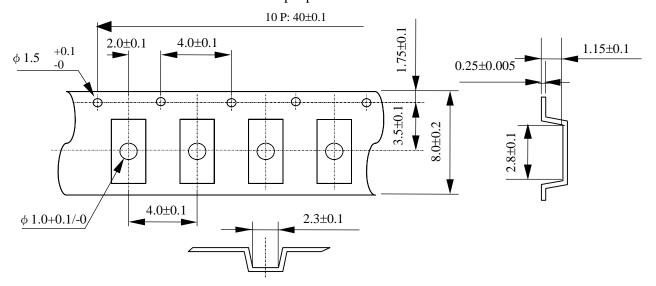
Item No.	Item	Page
[1]	Taping specification	1 to 2
[2]	Inner carton	3
[3]	Shipping carton	
[4]	Marking	4
[5]	Quantity	
[6]	Storage environment	
[7]	Handling	

[1] Taping specification

Subject to 「EIA-481」 and 「IEC-60286」

(1) Tape dimensions

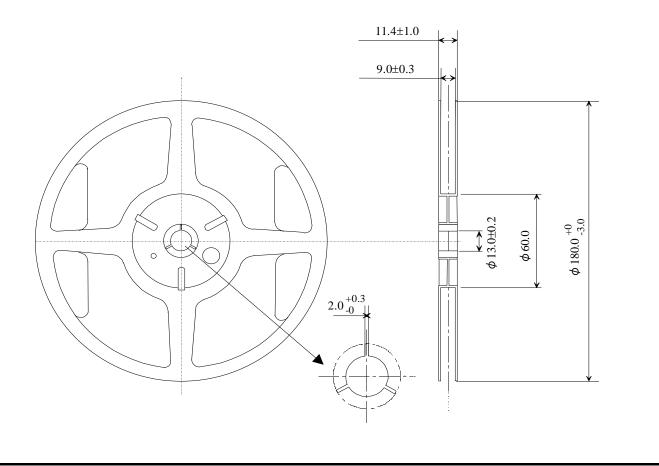
Material of the carrier tape : PSMaterial of the top tape : PET+PE



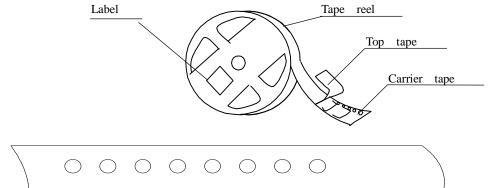
Unit: mm

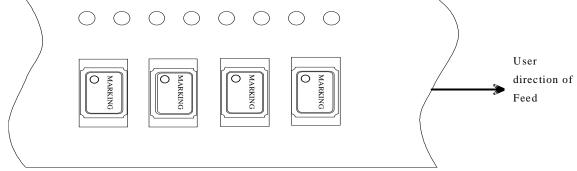
(2) Reel dimensions

Material of the reel: Conductive polystyrene

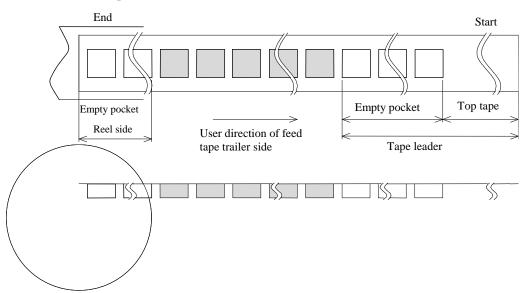


(3) Packing ①Tape & reel





②Start & end point



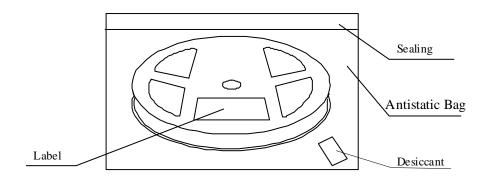
Ite	m	Empty space
Tape leader	Top tape	Min. 1 000 mm
	Carrier tape	Min. 160 mm
Tape trailer	Top tape	Min. 0 mm
	Carrier tape	Min. 160 mm

(4) Peel force of the cover tape

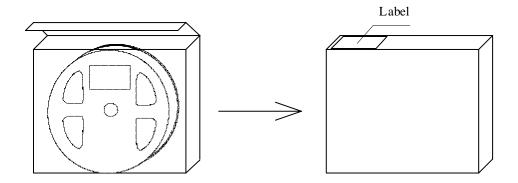
- \bigcirc angle : cover tape during peel off and the direction of unreeling shall be 165° to 180°.
- ② peel speed: 300 mm / min.

[2] Inner carton

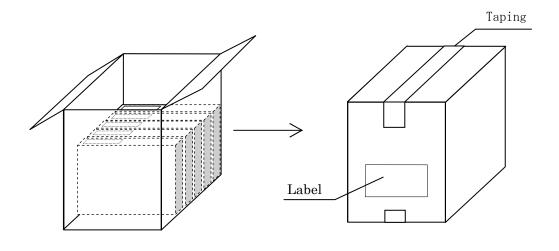
a) Packing to antistatic bag



b) Packing to inner carton



(3) Shipping carton



[4] Marking

- (1) Reel marking
 - Reel marking shall consist of:
 - 1) Parts name
 - 2) Quantity
 - 3) Manufacturing date or symbol
 - 4) Manufacturer's date or symbol
 - 5) Others (if necessary)
- (2) Inner carton marking
 - · Same as reel marking.
- (3) Shipping carton marking
 - · Shipping carton marking shall consist of:
 - 1) Parts name
 - 2) Quantity
- [5] Quantity
 - · 3 000 pcs./reel
- [6] Storage environment
 - (1) Before open the packing, we recommend to keep less than +30 °C and 85 %RH of Humidity, and to use it less than 6 months after delivery.
 - (2) We recommend to open Package in immediately before use. After open Package, We recommend to keeps less than 6 month. No need dry air before soldering work if it is less than temperature +30 °C, 85 humidity %RH.
 - (3) Not to expose the sun.
 - (4) Not to storage with some erosive chemicals.
 - (5) Nothing is allowed to put on the reel or carton to prevent mechanical damage.
- [7] Handling
 - To handle with care to prevent the damage of tape, reel and products.

No. SG210S*BA - 00 - ASE - 1

Crystal Oscillator SG-210S*BA

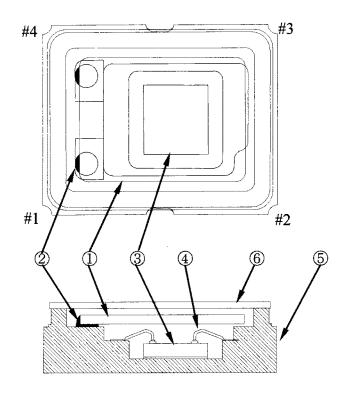
'13. 6.12 Manufacturing pocess chart No **Process** Setion Standards Inspection control item Instruments Inspection methods Record Lid Crystal In-coming Inspection Section Purchasing Specification Appearance Dimension MS Sampling Data sheet In-coming Inspection inspection Incoming Inspection Standard Inspection 2 Creaning China Plant Manufacturing Instruction Data sheet (Production Section) Sheet 3 China Plant Manufacturing Instruction Microscope Appearance 100% Inspection Data sheet Sputter (Production Section) Sheet Peeling Strength Scratch Sampling Data sheet Sampling Data sheet Frequency CI Meter China Plant Manufacturing Instruction MS Parts Mounting Sampling Data sheet Appearance Parts Mounting (Production Section) Sheet 5 China Plant Manufacturing Instruction hardening 5) hardening Sheet (Production Section) 3 Sputter Manufacturing Instruction Wire bonding China Plant Bonding strength Gauge Sampling Data sheet Wire bonding Sheet MS Data sheet (Production Section) Appearance 100% Inspection China Plant Manufacturing Instruction MS Crystal mounting Appearance Data sheet 100% Inspection 7 Crystal mounting Sheet (Production Section) China Plant Manufacturing Instruction hardening 8 hardening Sheet (Production Section) China Plant Manufacturing Instruction Frequency Frequency Counter Data sheet 100% Inspection \ Frequency Adjusting (Production Section) Sheet Adjusting 10 Temporary Hermetic China Plant Manufacturing Instruction 10 Temporary Hermetic Sheet Sealing (Production Section) Sealing 11 Baking China Plant Manufacturing Instruction (11) Baking Sheet (Production Section) Hermetic Sealing China Plant Manufacturing Instruction Appearance MS Sampling Data sheet (12) Hermetic Sealin Sheet (Production Section) (13) Heating 13 China Plant Manufacturing Instruction Heating Sheet (Production Section) China Plant M/C 14 Manufacturing Instruction Leakage Inspection Data sheet 100% Inspection Leakage **<14**> Leakage Sheet (Production Section) MS 15 China Plant Manufacturing Instruction Sampling Data sheet Appearance Marking Marking 15 Sheet (Production Section) China Plant M/C 16 Manufacturing Instruction Characteristic Inspection Data sheet 100% Inspection LDL Inspection 16 LDL Inspection Sheet (Production Section) Manufacturing Instruction M/C Electrical Characteristic 17 Electrical Characterist China Plant Electrical Characteristic 100% Inspection Data sheet Sheet (Production Section) 18 Temp Characteristic M/C China Plant Manufacturing Instruction Temp Characteristic Sampling Data sheet Temp Characteristic Sheet Inspection (Production Section) 19 High temp China Plant Electrical Characteristic M/C 19 Manufacturing Instruction High temp 100% Inspection Data sheet Ele Characteristic Sheet (Production Section) Ele Characteristic (20) Visual inspection 20 Visual inspection China Plant Manufacturing Instruction MS Data sheet Appearance 100% Inspection Sheet (Production Section) Delivery Specifications M/C Outgoing inspection China Plant Electrical Characteristic 21 Sampling Data sheet Outgoing inspection Outgoing Inspection Standard Appearance MS (Inspection Section) 22 China Plant Manufacturing Instruction Tape peeling Strength M/C Sampling Data sheet **Taping** 22 **Taping** Sheet M/C Frequency check Data sheet (Production Section) 100% Inspection **Appearance** 23 Packing Chaina Plant Manufacturing Instruction Customers Delivery Packing (Production Control Slip Sheet Type

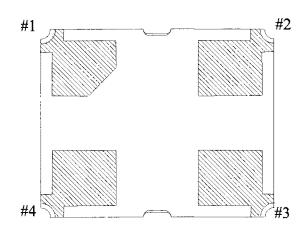
Daily Shipping List

Quantity

Section)

Structure diagram SG-210S*B





Material
AT cut
Ag paste
C-MOS
Ag paste
Au
Ceramic (Al ₂ 0 ₂)
Cover

RELIABILITY TEST DATA

Product Name: SG-210**B series (High temperature)

The Company evaluation condition

We evaluate environmental and mechanical characteristics by the following test condition . No. OUT8-34-0097-003E

		and incenamear characteristics by the following	VALUE *1			FAIL
No.	ITEM	TEST CONDITIONS	Df/f *2	Electrical	Qty	Qty
			$[1 \pm 10^{-6}]$	characteristics	[n]	[n]
1	High temperature storage	+125 °C × 1 000 h	*3 ± 20		22	0
2	Low temperature storage	-40 °C × 1 000 h	*3 ± 10	i i	22	0
3	High temperature bias	+125 °C × Spec bias × 1 000 h	*3 ± 20		22	0
4	Low temperature bias	-40 °C × Spec bias × 1 000 h	*3 ± 10		22	0
5	Temperature humidity bias	+85 °C × 85 %RH × Spec bias × 1 000 h	*3 ± 10	Satisfy specification after test	22	0
6	Temperature cycle	-40 °C ⇔ +125 °C 30 min at each temp. 1000 cycles	*3 ± 10		22	0
7	Resistance to soldering heat	For convention reflow soldering furnace (3 times) Ref. IEC/JEDEC J-STD-020D.1	± 5		22	0
8	Shock	100 g dummy (EPSON Standard) drop from 1 500 mm height on to the concrete 3 directions 10 times	± 3	:	22	0
9	Vibration	10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s ² 10 Hz \rightarrow 500 Hz \rightarrow 10 Hz 15 min / cycle 6 h (2 h × 3 directions)	± 2		22	0
10	Seal	He leakage detector	1 × 10 ⁻⁹ Pa·m ³ /s MAX		11	0
11	Solderability	Dip termination into solder bath at +235 °C ± 5 °C for 5 s (Using Rosin Flux)	Termination must be 95 % covered with fresh solder		11	0
12	Pull-off	10N press for 10s ± 1s Ref.EIAJ ED-4702	No Peeling-off at a solder part		1.1	0

Notes

- 1. *1 Each test done independently.
- 2. *2 Measuring 2 h to 24 h later leaving in room temperature after each test.
- 3. *3 Initial value shall be measured after 24 h storage at room temperature after pre-conditioning. Pre-conditioning: Reflow (3 time)

Product Name: SG-210**B series (High temperature)

